

BT155W-1400T

Rev.01 - 22 December 2020

Product data sheet

1. General description

SCR

Planar passivated Silicon Controlled Rectifier in a TO247 plastic package intended for use in applications requiring very high inrush current capability and high thermal cycling performance.

2. Features and benefits

- High thermal cycling performance
- · Planar passivated for voltage ruggedness and reliability
- High voltage capacity
- · Very high current surge capability

3. Applications

- Line rectifying 50/60 Hz
- Softstart AC motor control
- DC Motor control
- Power converter
- AC power control
- Lighting and temperature control
- Uninterruptible Power Supply (UPS)
- Solid State Relay (SSR)
- Traction battery charging

4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Absolute	maximum rating						
V_{DRM}	repetitive peak off-state voltage			-	-	1400	V
V_{RRM}	repetitive peak reverse voltage			-	-	1400	V
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 130 °C; <u>Fig. 1</u> ; <u>Fig. 2; Fig. 3</u>		-	-	79	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5		-	-	650	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms		-	-	715	А
T _j	junction temperature			-	-	150	°C

SCR

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	aracteristics						
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7; Fig. 8</u>		-	-	50	mA
Dynamic	Dynamic characteristics						
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 938 V; T _j = 125 °C; Gate open circuit; (V_{DM} = 67% of V_{DRM}); exponential waveform		1500	-	-	V/µs

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode		
2	A	anode		A H K G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
BT155W-1400T	TO247	BT155W-1400TQ	Tube	30	TO247N	20-July-2016		

7. Marking

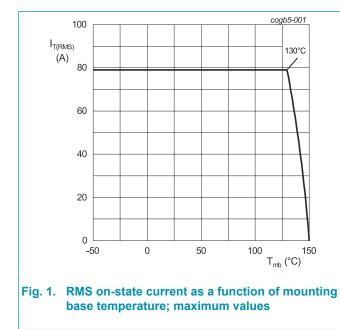
Table 4. Marking codes	
Type number	Marking codes
BT155W-1400T	BT155W 1400T

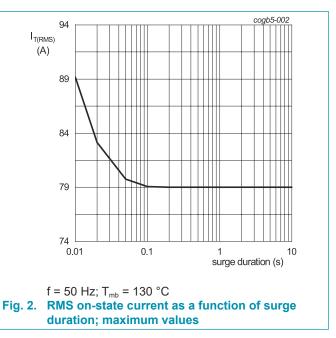
8. Limiting values

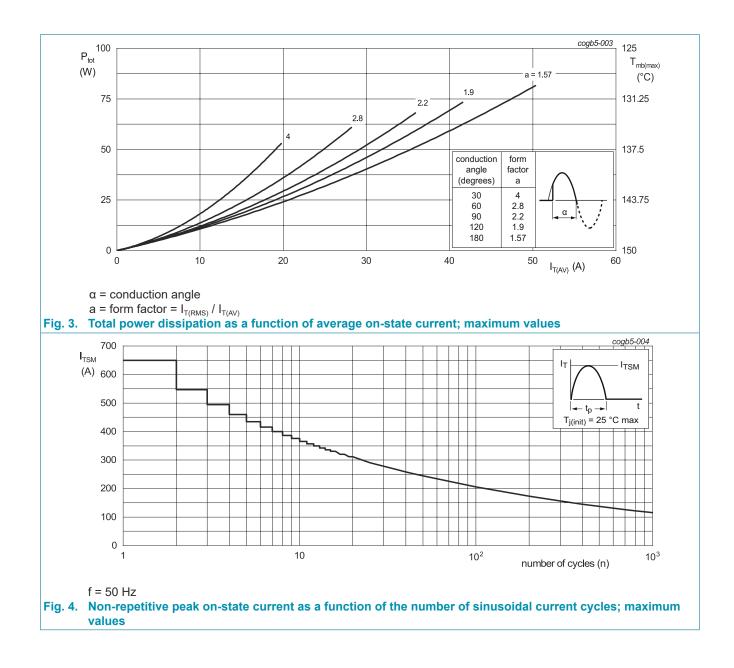
Table 5. Limiting values

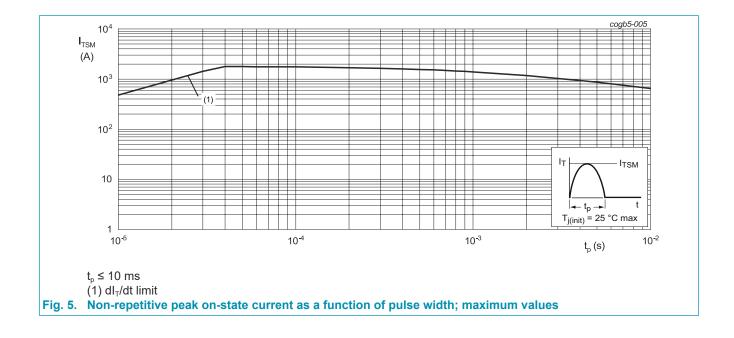
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	1400	V
V _{RRM}	repetitive peak reverse voltage		-	1400	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 130 °C	-	50	А
$\mathbf{I}_{\mathrm{T}(\mathrm{RMS})}$	RMS on-state current	half sine wave; T _{mb} ≤ 130 °C; <u>Fig 1; Fig 2; Fig 3</u>	-	79	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig 4; Fig 5	-	650	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	-	715	А
l ² t	l ² t for fusing	t _p = 10 ms; sine-wave pulse	-	2113	A ² s
dl _T /dt	rate of rise of on-state current	I _G = 200mA	-	150	A/µs
I _{GM}	peak gate current		-	8	А
V_{RGM}	peak reverse gate voltage		-	5	V
P_{GM}	peak gate power		-	20	W
$P_{G(AV)}$	average gate power	over any 20 ms period	-	1	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C







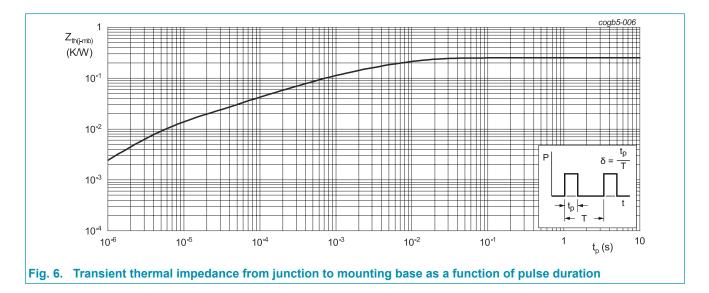


9. Thermal & Mechanical characteristics

Table 6. Thermal & Mechanical characteristics

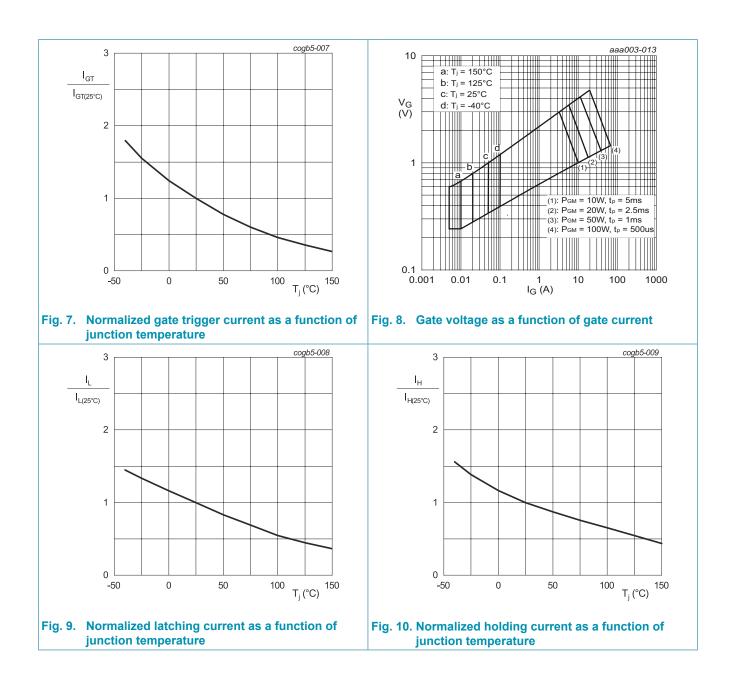
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig 6</u>	-	-	0.25	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air	-	50	-	K/W
	Mounting torque	M3 screw mounting	0.55	-	0.8	Nm

Note: It is recommended that a metal washer is inserted between screw head and mounting tab. Do not use self-tapping screws.



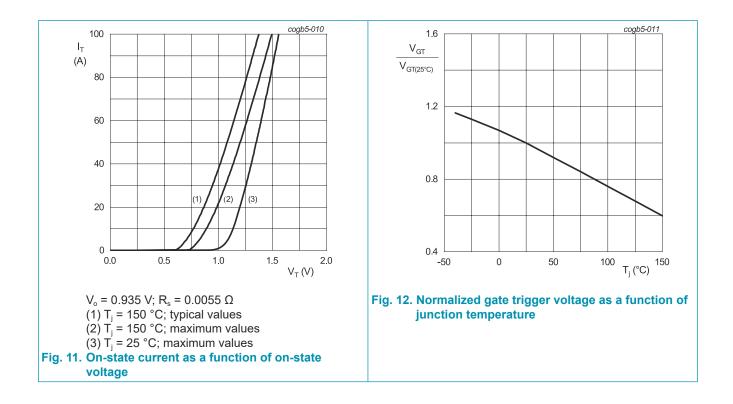
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics	· · · · · ·				
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C};$ Fig. 7; Fig. 8	-	-	50	mA
IL	latching current	latching current $V_D = 12 \text{ V}; \text{ I}_G = 0.1 \text{ A}; \text{ T}_j = 25 \text{ °C};$ Fig. 9		-	300	mA
I _H	holding current $V_D = 12 V; T_j = 25 °C; Fig. 10$		-	-	200	mA
V _T on-	on-state voltage	I _T = 50 A; T _j = 25 °C; <u>Fig. 11</u>	-	-	1.35	V
		I _T = 90 A; T _j = 25 °C; <u>Fig. 11</u>	-	-	1.6	V
V _{gt}	gate trigger voltage	$V_{\rm D}$ = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 12</u>	-	0.7	1	V
		V _D = 800 V; I _T = 0.1 A; T _j = 125 °C	0.25	0.4	-	V
I _D	off-state current	V _D = 1400 V; T _j = 25 °C	-	-	10	μA
		V _D = 1400 V; T _j = 125 °C	-	-	4	mA
		V _D = 1400 V; T _j = 150 °C	-	-	10	mA
I _R	reverse current	V _D = 1400 V; T _j = 25 °C	-	-	10	μA
		V _D = 1400 V; T _j = 125 °C	-	-	4	mA
		V _D = 1400 V; T _j = 150 °C	-	-	10	mA
Dynamic	characteristics	· · ·	I		_	_
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 938 V; T _j = 125 °C; Gate open circuit; (V _{DM} = 67% of V _{DRM}); exponential waveform	1500	-	-	V/µs
		V_{DM} = 938 V; T _j = 150 °C; Gate open circuit; (V _{DM} = 67% of V _{DRM}); exponential waveform	1000	-	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 40 \text{ A}; V_D = 800 \text{ V}; I_G = 0.1 \text{ A}; dI_G/dt = 5 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$	-	2	-	μs
t _q	commutated turn-off time		-	150	-	μs

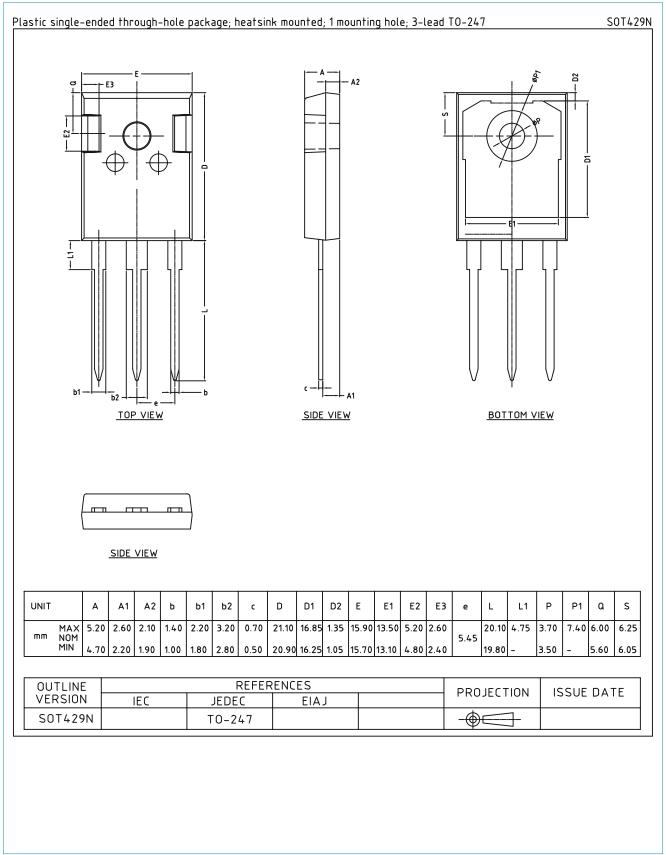


WeEn Semiconductors

BT155W-1400T



11. Package outline



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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